

Vishay Semiconductors

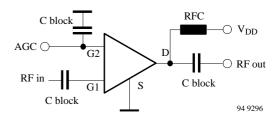
MOSMIC[®] for TV–Tuner Prestage with 12 V Supply Voltage

MOSMIC - MOS Monolithic Integrated Circuit

Applications

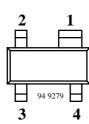
Low noise gain controlled input stages in UHF-and VHF- tuner with 12 V supply voltage.

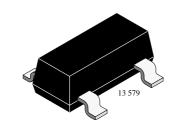
Electrostatic sensitive device. Observe precautions for handling.



Features

- Integrated gate protection diodes
- Low noise figure
- High gain
- Biasing network on chip



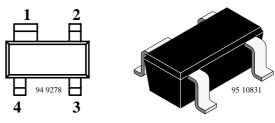


S849T Marking: 849 Plastic case (SOT 143) 1 = Source, 2 = Drain, 3 = Gate 2, 4 = Gate 1

Absolute Maximum Ratings

 $T_{amb} = 25^{\circ}C$, unless otherwise specified

- Improved cross modulation at gain reduction
- High AGC-range
- SMD package



S849TR Marking: 49R Plastic case (SOT 143R) 1 = Source, 2 = Drain, 3 = Gate 2, 4 = Gate 1

| Parameter | Test Conditions | Symbol | Value | Unit |
|-------------------------------------|--------------------------|-----------------------|-------------|------|
| Drain - source voltage | | V _{DS} | 16 | V |
| Drain current | | I _D | 30 | mA |
| Gate 1/Gate 2 - source peak current | | ±IG1/G2SM | 10 | mA |
| Gate 1/Gate 2 - source voltage | | ±V _{G1/G2SM} | 7.5 | V |
| Total power dissipation | T _{amb} ≤ 60 °C | P _{tot} | 200 | mW |
| Channel temperature | | T _{Ch} | 150 | °C |
| Storage temperature range | | T _{stg} | -55 to +150 | °C |

Maximum Thermal Resistance

 $T_{amb} = 25^{\circ}C$, unless otherwise specified

| Parameter | Test Conditions | Symbol | Value | Unit |
|-----------------|--|--------------------|-------|------|
| Channel ambient | on glass fibre printed board (25 x 20 x 1.5) mm ³ plated with 35 μ m Cu | R _{thChA} | 450 | K/W |

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Electrical DC Characteristics

 $T_{amb} = 25^{\circ}C$, unless otherwise specified

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|--------------------------------------|---|------------------------|-----|-----|-----|------|
| Gate 1 - source breakdown voltage | $\pm I_{G1S}$ = 10 mA, V_{G2S} = V_{DS} = 0 | ±V _{(BR)G1SS} | 8 | | 12 | V |
| Gate 2 - source breakdown voltage | $\pm I_{G2S}$ = 10 mA, V_{G1S} = V_{DS} = 0 | ±V _{(BR)G2SS} | 8 | | 12 | V |
| Gate 1 - source | $+V_{G1S} = 6 V, V_{G2S} = V_{DS} = 0$ | +I _{G1SS} | | | 60 | μA |
| leakage current | $-V_{G1S} = 6 V, V_{G2S} = V_{DS} = 0$ | -I _{G1SS} | | | 120 | μA |
| Gate 2 - source leakage current | $\pm V_{G2S} = 6 V, V_{G1S} = V_{DS} = 0$ | ±I _{G2SS} | | | 20 | nA |
| Drain current | $V_{DS} = 12 \text{ V}, V_{G1S} = 0, V_{G2S} = 6 \text{ V}$ | I _{DSS} | 50 | | 500 | μA |
| Self-biased operating current | $V_{DS} = 12 \text{ V}, V_{G1S} = \text{nc}, V_{G2S} = 6 \text{ V}$ | I _{DSP} | 8 | 12 | 16 | mA |
| Gate 2 - source cut-off voltage | V_{DS} = 12 V, V_{G1S} = nc, I_{D} = 200 µA | V _{G2S(OFF)} | | 1.0 | | V |

Electrical AC Characteristics

 V_{DS} = 12 V, V_{G2S} = 6 V, f = 1 MHz , T_{amb} = 25°C, unless otherwise specified

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|--------------------------|---|--------------------|------|-----|-----|------|
| Forward transadmittance | | y _{21s} | 20 | 24 | 28 | mS |
| Gate 1 input capacitance | | C _{issg1} | | 2.1 | 2.5 | pF |
| Feedback capacitance | | C _{rss} | | 20 | | fF |
| Output capacitance | | C _{oss} | | 0.9 | | pF |
| Power gain | $G_{S} = 2 \text{ mS}, G_{L} = 0.5 \text{ mS}, f = 200 \text{ MHz}$ | G _{ps} | | 26 | | dB |
| | G _S = 3,3 mS, G _L = 1 mS, f = 800 MHz | G _{ps} | 16.5 | 20 | | dB |
| AGC range | $V_{DS} = 12 \text{ V}, V_{G2S} = 1 \text{ to } 6 \text{ V}, \text{ f} = 800 \text{ MHz}$ | ΔG_{ps} | 40 | | | dB |
| Noise figure | G _S = 2 mS, G _L = 0.5 mS, f = 200 MHz | F | | 1 | | dB |
| | G _S = 3,3 mS, G _L = 1 mS, f = 800 MHz | F | | 1.3 | | dB |

Caution for Gate 1 switch-off mode:

No external DC-voltage on Gate 1 in active mode! Switch-off at Gate 1 with $V_{G1S} < 0.7$ V is feasible. Using open collector switching transistor (inside of PLL), insert 10 k Ω collector resistor.



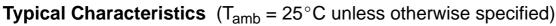
Common Source S–Parameters

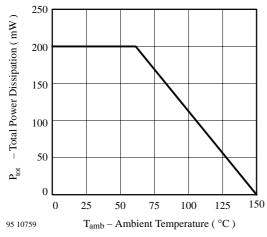
 V_{DS} = 12 V , V_{G2S} = 6 V , $~Z_{0}$ = 50 $\Omega,~T_{amb}$ = 25 $^{\circ}C,$ unless otherwise specified

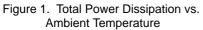
| | S1 | 1 | S2 | 21 | S1 | 2 | S2 | S22 | |
|-------|------------|-------|------------|-------|------------|-------|------------|-------|--|
| f/MHz | LOG MAG | ANG | LOG MAG | ANG | LOG MAG | ANG | LOG MAG | ANG | |
| | dB | deg | dB | deg | dB | deg | dB | deg | |
| 50 | -0.01 | -3.9 | 7.46 | 175.0 | -61.64 | 87.7 | -0.17 | -1.7 | |
| 100 | -0.04 | -7.6 | 7.37 | 169.3 | -55.58 | 85.2 | -0.20 | -3.3 | |
| 150 | -0.11 | -11.5 | 7.30 | 163.4 | -52.05 | 82.0 | -0.22 | -5.0 | |
| 200 | -0.16 | -15.1 | 7.21 | 157.8 | -49.78 | 79.5 | -0.25 | -6.6 | |
| 250 | -0.28 | -19.1 | 7.09 | 151.8 | -48.15 | 76.4 | -0.26 | -8.4 | |
| 300 | -0.39 | -22.4 | 6.98 | 146.8 | -46.79 | 75.0 | -0.31 | -9.8 | |
| 350 | -0.51 | -26.0 | 6.79 | 141.2 | -45.92 | 72.6 | -0.34 | -11.3 | |
| 400 | -0.65 | -29.4 | 6.66 | 136.0 | -45.15 | 70.9 | -0.38 | -12.8 | |
| 450 | -0.79 | -32.7 | 6.47 | 131.0 | -44.66 | 69.5 | -0.44 | -14.3 | |
| 500 | -0.95 | -35.8 | 6.29 | 125.8 | -44.28 | 67.8 | -0.48 | -15.9 | |
| 550 | -1.09 | -39.0 | 6.13 | 121.0 | -44.13 | 67.3 | -0.53 | -17.4 | |
| 600 | -1.26 | -42.2 | 5.91 | 116.0 | -44.04 | 68.0 | -0.59 | -18.8 | |
| 650 | -1.41 | -45.1 | 5.76 | 111.8 | -43.84 | 68.6 | -0.63 | -20.2 | |
| 700 | -1.56 | -48.3 | 5.55 | 106.9 | -43.97 | 69.2 | -0.65 | -21.6 | |
| 750 | -1.71 | -50.9 | 5.40 | 102.6 | -44.18 | 70.4 | -0.72 | -23.1 | |
| 800 | -1.89 | -53.6 | 5.22 | 98.0 | -44.54 | 73.2 | -0.76 | -24.4 | |
| 850 | -2.02 | -56.7 | 5.08 | 93.8 | -44.81 | 77.0 | -0.80 | -25.9 | |
| 900 | -2.15 | -59.5 | 4.89 | 89.4 | -45.03 | 83.4 | -0.85 | -27.6 | |
| 950 | -2.28 | -62.3 | 4.75 | 85.2 | -44.87 | 90.8 | -0.90 | -29.0 | |
| 1000 | -2.45 | -65.1 | 4.55 | 80.9 | -44.59 | 95.7 | -0.96 | -30.2 | |
| 1050 | -2.59 | -67.8 | 4.38 | 76.2 | -44.59 | 100.2 | -1.07 | -31.6 | |
| 1100 | -2.75 | -70.5 | 4.20 | 72.2 | -44.54 | 108.4 | -1.11 | -33.0 | |
| 1150 | -2.81 | -73.3 | 4.14 | 67.9 | -44.05 | 116.7 | -1.13 | -34.7 | |
| 1200 | -2.96 | -75.7 | 4.02 | 64.3 | -43.33 | 125.5 | -1.15 | -36.2 | |
| 1250 | -3.07 | -78.7 | 3.90 | 60.1 | -42.41 | 133.5 | -1.18 | -37.6 | |
| 1300 | -3.18 | -81.4 | 3.73 | 55.6 | -41.13 | 139.3 | -1.26 | -39.1 | |



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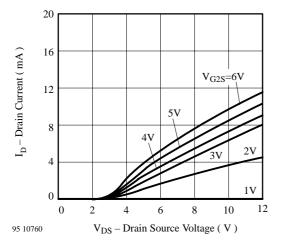
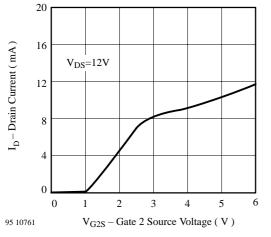
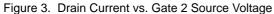


Figure 2. Drain Current vs. Drain Source Voltage





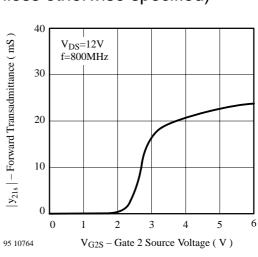


Figure 4. Forward Transadmittance vs. Gate 2 Source Voltage

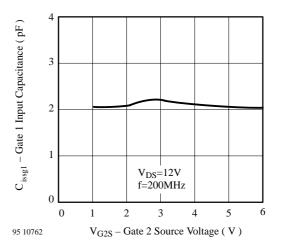


Figure 5. Gate 1 Input Capacitance vs. Gate 2 Source Voltage

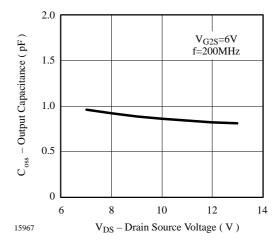


Figure 6. Output Capacitance vs. Drain Source Voltage



S849T/S849TR Vishay Semiconductors

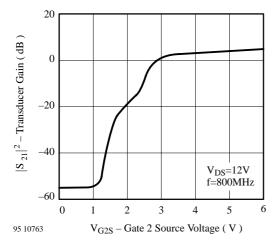


Figure 7. Transducer Gain vs. Gate 2 Source Voltage

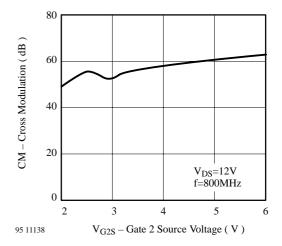


Figure 8. Cross Modulation vs. Gate 2 Source Voltage

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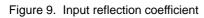


 V_{DS} = 8 V, I_{D} = 10 mA, V_{G2S} = 4 V , Z_{0} = 50 Ω

S₁₁

0

j j0.5 j2 j0.2 j5 0.5 ∞ 0.2 50 300 -j0.2 800 1300MHz -j0.5 _j2 12 948 -j



S₂₁

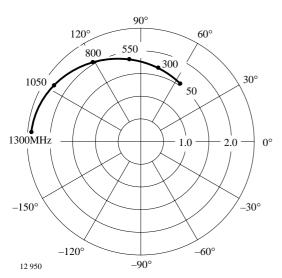
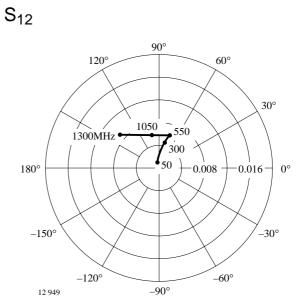
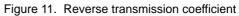


Figure 10. Forward transmission coefficient





S₂₂

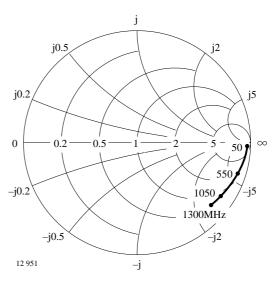
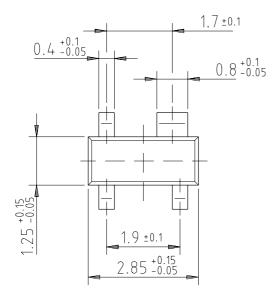


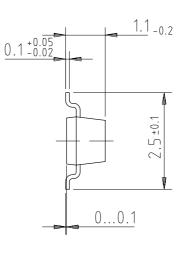
Figure 12. Output reflection coefficient



S849T/S849TR Vishay Semiconductors

Dimensions of S849T in mm



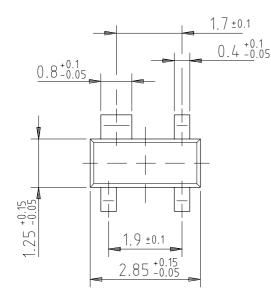


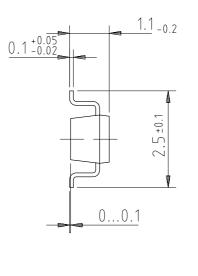
96 12240



technical drawings according to DIN specifications

Dimensions of S849TR in mm





96 12239





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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.

2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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